

8-Bit I/O Expander with Open-Drain Outputs

Features

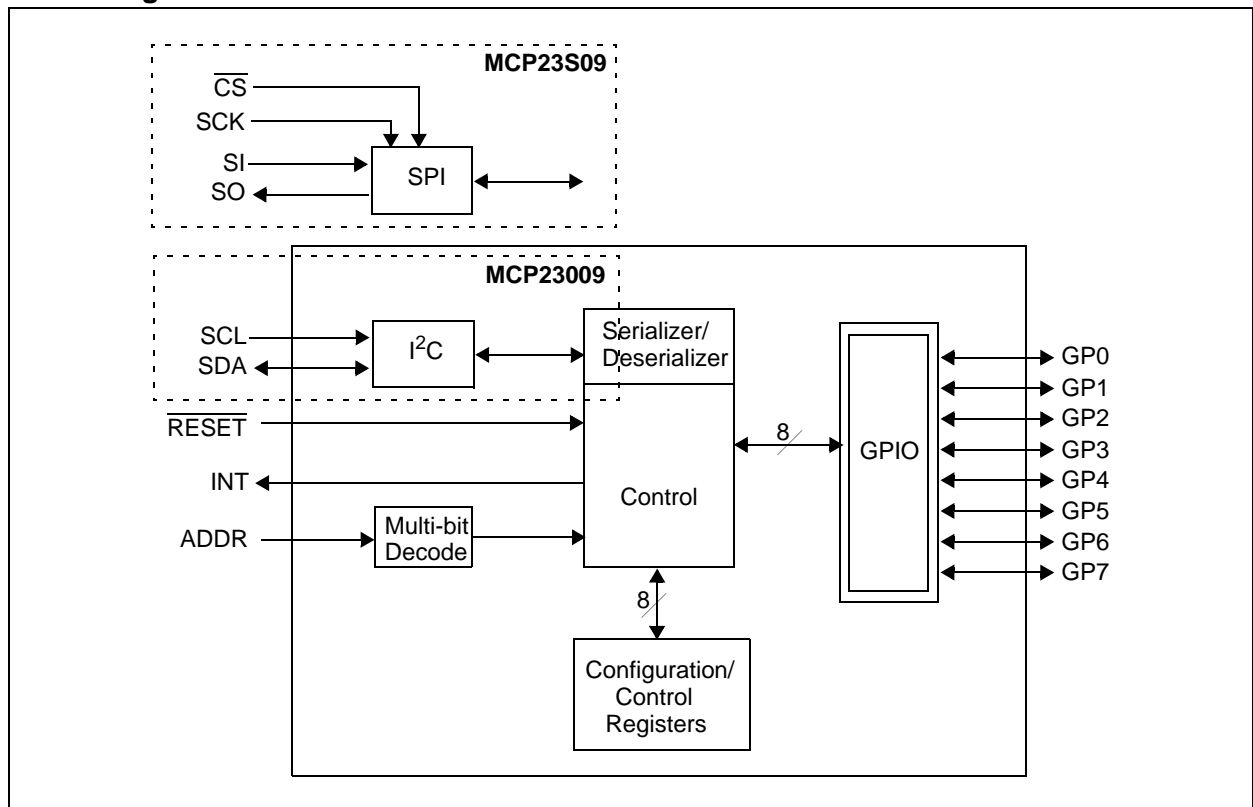
- 8-bit remote bidirectional I/O port:
 - I/O pins default to input
- Open-drain outputs:
 - 5.5V tolerant
 - 25 mA sink capable (per pin)
 - 200 mA total
- High-speed I²C™ interface: **(MCP23009)**
 - 100 kHz
 - 400 kHz
 - 3.4 MHz
- High-speed SPI interface: **(MCP23S09)**
 - 10 MHz
- Single hardware address pin: **(MCP23009)**
 - Voltage input to allow up to eight devices on the bus
- Configurable interrupt output pins:
 - Configurable as active-high, active-low or open-drain

- Configurable interrupt source:
 - Interrupt-on-change from configured defaults or pin change
- Polarity inversion register to configure the polarity of the input port data
- External reset input
- Low standby current:
 - 1 μ A ($-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$)
 - 6 μ A ($+85^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$)
- Operating voltage:
 - 1.8V to 5.5V

Packages

- 16-pin QFN (3x3 [mm])
- 18-pin PDIP (300 mil)
- 18-pin SOIC (300 mil)
- 20-pin SSOP

Block Diagram

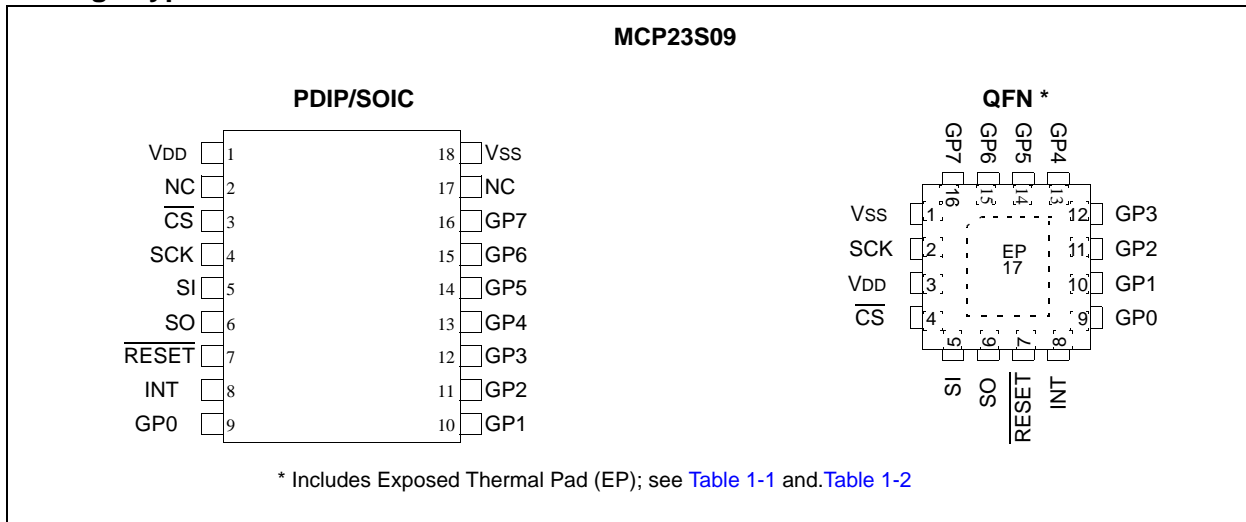


MCP23009/MCP23S09

Package Types:



Package Types:



1.0 DEVICE OVERVIEW

The MCP23X09 device provides 8-bit, general purpose parallel I/O expansion for I²C bus or SPI applications. The two devices differ only in the serial interface.

- MCP23009 - I²C interface
- MCP23S09 - SPI interface

The MCP23X09 consists of multiple 8-bit configuration registers for input, output and polarity selection. The system master can enable the I/Os as either inputs or outputs by writing the I/O configuration bits. The data for each input or output is kept in the corresponding input or output register. The polarity of the input port register can be inverted with the polarity inversion register. All registers can be read by the system master.

The interrupt output can be configured to activate under two conditions (mutually exclusive):

1. When any input state differs from its corresponding input port register state. This is used to indicate to the system master that an input state has changed.
2. When an input state differs from a pre-configured register value (DEFVAL register).

The Interrupt Capture register captures port values at the time of the interrupt, thereby saving the condition that caused the interrupt.

The Power-on Reset (POR) sets the registers to their default values and initializes the device state machine.

The hardware address pin is used to determine the device address.

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1.1 Pin Descriptions

TABLE 1-1: I²C PINOUT DESCRIPTION (MCP23009)

| Pin Name | 18LD PDIP/ SOIC | 16LD QFN | 20LD SSOP | Pin Type | Standard Function |
|----------|-----------------|----------|----------------|----------|---|
| VDD | 1 | 3 | 1 | P | Power |
| VSS | 18 | 1 | 20 | P | Ground |
| SCL | 3 | 4 | 3 | I | Serial clock input |
| SDA | 4 | 5 | 4 | I/O | Serial data I/O |
| ADDR | 5 | 6 | 5 | I | Hardware address pin allows up to 8 slave devices on the bus |
| RESET | 6 | 7 | 6 | I | Hardware reset |
| INT | 7 | 8 | 7 | O | Interrupt output for port. Can be configured as active high, active low, or open-drain. |
| GP0 | 8 | 9 | 8 | I/O | Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor. |
| GP1 | 9 | 10 | 9 | I/O | Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor. |
| GP2 | 10 | 11 | 12 | I/O | Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor. |
| GP3 | 11 | 12 | 13 | I/O | Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor. |
| GP4 | 12 | 13 | 14 | I/O | Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor. |
| GP5 | 13 | 14 | 15 | I/O | Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor. |
| GP6 | 14 | 15 | 16 | I/O | Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor. |
| GP7 | 15 | 16 | 17 | I/O | Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor. |
| NC | 2, 16, 17 | 2 | 2,10, 11,19,18 | | Not connected |
| EP | — | 17 | | | Exposed Thermal Pad (EP). Do not electrically connect. Can connect to VSS. |

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TABLE 1-2: SPI PINOUT DESCRIPTION (MCP23S09)

| Pin Name | 18LD PDIP/ SOIC | 16LD QFN | Pin Type | Standard Function |
|----------|-----------------|----------|----------|---|
| VDD | 1 | 3 | P | Power (high current capable) |
| VSS | 18 | 1 | P | Ground (high current capable) |
| CS | 3 | 4 | I | Chip select |
| SCK | 4 | 2 | I | Serial clock input |
| SI | 5 | 5 | I | Serial data input |
| SO | 6 | 6 | O | Serial data out |
| RESET | 7 | 7 | I | Hardware reset (must be externally biased) |
| INT | 8 | 8 | O | Interrupt output for port. Can be configured as active high, active low, or open-drain. |
| GP0 | 9 | 9 | I/O | Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor. |
| GP1 | 10 | 10 | I/O | Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor. |
| GP2 | 11 | 11 | I/O | Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor. |
| GP3 | 12 | 12 | I/O | Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor. |
| GP4 | 13 | 13 | I/O | Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor. |
| GP5 | 14 | 14 | I/O | Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor. |
| GP6 | 15 | 15 | I/O | Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor. |
| GP7 | 16 | 16 | I/O | Bidirectional I/O Pin (5.5 volt tolerant inputs; open-drain outputs). Can be enabled for interrupt on change, and/or internal pull-up resistor. |
| NC | 2, 17 | — | — | Not connected |
| EP | — | 17 | — | Exposed Thermal Pad (EP). Do not electrically connect, Can connect to VSS. |

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1.2 Power-on Reset (POR)

The on-chip POR circuit holds the device in reset until VDD has reached a high enough voltage to deactivate the POR circuit (i.e., release the device from reset). The maximum VDD rise time is specified in the electrical specification section.

When the device exits the POR condition (releases reset), device operating parameters (i.e., voltage, temperature, serial bus frequency, etc.) must be met to ensure proper operation.

1.3 Serial Interface

This block handles the functionality of the I²C (MCP23009) or SPI (MCP23S09) interface protocol. The MCP23X09 contains eleven (11) individual registers which can be addressed through the Serial Interface block (Table 1-3).

TABLE 1-3: REGISTER ADDRESSES

| Address | Access to: |
|---------|--------------------|
| 00h | IODIR |
| 01h | IPOL |
| 02h | GPINTEN |
| 03h | DEFVAL |
| 04h | INTCON |
| 05h | IOCON |
| 06h | GPPU |
| 07h | INTF |
| 08h | INTCAP (Read-only) |
| 09h | GPIO |
| 0Ah | OLAT |

1.3.1 BYTE MODE AND SEQUENTIAL MODE

The MCP23X09 has the ability to operate in “Byte Mode” or “Sequential Mode” (IOCON.SEQOP). Byte mode and sequential mode are not to be confused with I²C byte operations and sequential operations. The modes explained here relate to the device’s internal address pointer and whether or not it is incremented after each byte is clocked on the serial interface.

Byte Mode disables automatic address pointer incrementing. When operating in Byte Mode, the MCP23X09 does not increment its internal address counter after each byte during the data transfer. This gives the ability to continually access the same address by providing extra clocks (without additional control bytes). This is useful for polling the GPIO register for data changes or for continually writing to the output latches.

Sequential Mode enables automatic address pointer incrementing. When operating in Sequential Mode, the MCP23X09 increments its address counter after each

byte during the data transfer. The address pointer automatically rolls over to address 00h after accessing the last register.

These two modes are not to be confused with single writes/reads and continuous writes/reads which are serial protocol sequences. For example, the device may be configured for Byte Mode and the master may perform a continuous read. In this case, the MCP23X09 would not increment the address pointer and would repeatedly drive data from the same location.

1.3.2 I²C INTERFACE

1.3.2.1 I²C Write Operation

The I²C write operation includes the control byte and register address sequence, as shown in the bottom of Figure 1-1. This sequence is followed by eight bits of data from the master and an Acknowledge (ACK) from the MCP23009. The operation is ended with a stop (P) or restart (SR) condition being generated by the master.

Data is written to the MCP23009 after every byte transfer. If a stop or restart condition is generated during a data transfer, the data will not be written to the MCP23009.

Both “byte mode” and “sequential mode” are supported by the MCP23009. If sequential mode is enabled (default), the MCP23009 increments its address counter after each ACK during the data transfer.

1.3.2.2 I²C Read Operation

I²C read operations include the control byte sequence, as shown in the bottom of Figure 1-1. This sequence is followed by another control byte (including the Start condition and ACK) with the R/W bit equal to a logic one (R/W = 1). The MCP23009 then transmits the data contained in the addressed register. The sequence is ended with the master generating a Stop or Restart condition.

1.3.2.3 I²C Sequential Write/Read

For sequential operations (Write or Read), instead of transmitting a Stop or Restart condition after the data transfer, the master clocks the next byte pointed to by the address pointer (see Section 1.3.1 “Byte Mode and Sequential Mode” for details regarding sequential operation control).

The sequence ends with the master sending a Stop or Restart condition.

The MCP23009 address pointer will roll over to address zero after reaching the last register address.

Refer to Figure 1-1.

1.3.3 SPI INTERFACE

The MCP23S09 operates in Mode 0,0 and Mode 1,1. The difference between the two modes is the idle state of the clock.

Mode 0,0: The idle state of the clock is LOW. Input data is latched on the rising edge of the clock; output data is driven on the falling edge of the clock.

Mode 1,1: The idle state of the clock is HIGH. Input data is latched on the rising edge of the clock; output data is driven on the falling edge of the clock.

1.3.3.1 SPI Write Operation

The SPI write operation is started by lowering \overline{CS} . The write command (slave address with R/W bit cleared) is then clocked into the device. The opcode is followed by an address and at least one data byte.

1.3.3.2 SPI Read Operation

The SPI read operation is started by lowering \overline{CS} . The SPI read command (slave address with R/W bit set) is then clocked into the device. The opcode is followed by an address, with at least one data byte being clocked out of the device.

1.3.3.3 SPI Sequential Write/Read

For sequential operations, instead of deselecting the device by raising \overline{CS} , the master clocks the next byte pointed to by the address pointer. (see **Section 1.3.1 “Byte Mode and Sequential Mode”** for details regarding sequential operation control).

The sequence ends by the raising of \overline{CS} .

The MCP23S09 address pointer will roll over to address zero after reaching the last register address.

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FIGURE 1-1: MCP23009 I²C™ DEVICE PROTOCOL



1.4 Multi-bit Address Decoder

The ADDR pin is used to set the slave address of the MCP23009 (I²C only) to allow up to eight devices on the bus using only a single pin. Typically, this would require three pins.

The multi-bit Address Decoder employs a basic FLASH ADC architecture (Figure 1-4). The seven comparators generate 8 unique values based on the analog input. This value is converted to a 3-bit code which corresponds to the address bits (A2, A1, A0) in the serial OPCODE.

Sequence of Operation (see Figure 1-5 for timings):

1. Upon power up (after VDD stabilizes) the module becomes active after time tADEN. Note, the analog value on the ADDR pin must be stable before this point to ensure accurate address assignment.

2. The 3-bit address is latched after tADDRLAT.
3. The module powers down after the first rising edge of the serial clock is detected (tADDIS).

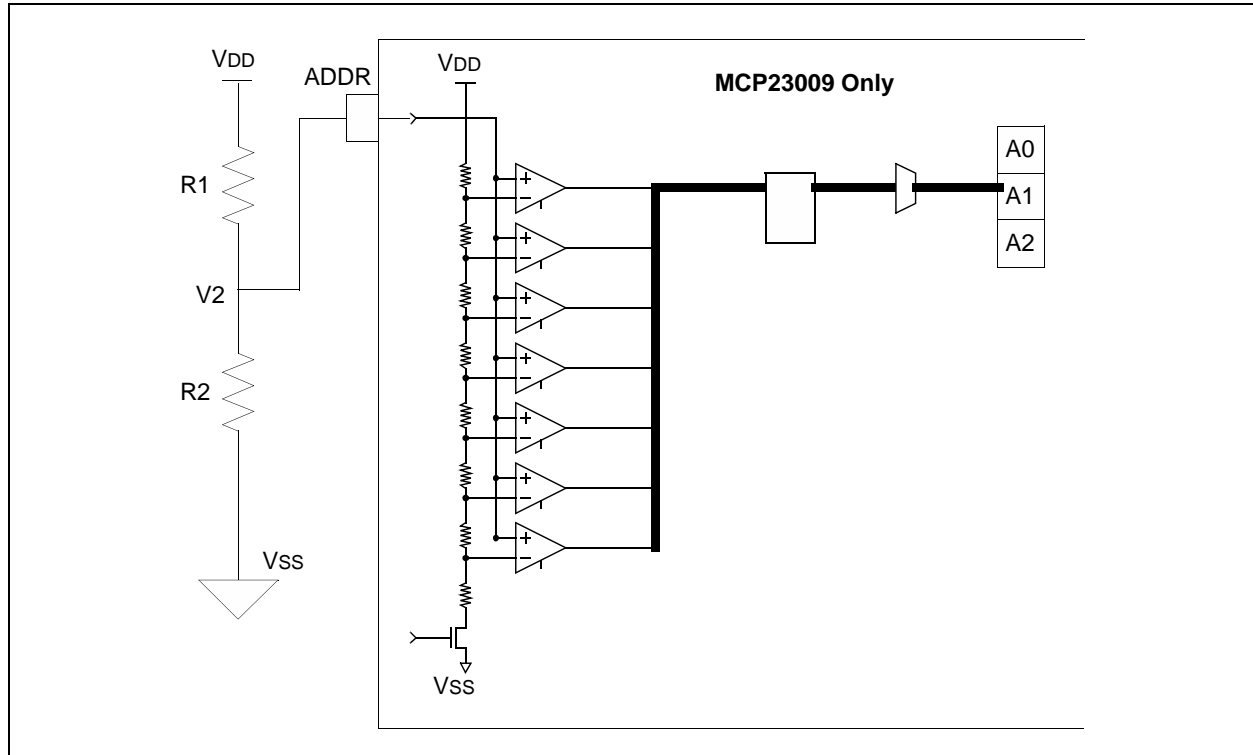
Once the address bits are latched, the device will keep the slave address until a POR or reset condition occurs.

1.4.1 CALCULATING VOLTAGE ON ADDR

When calculating the required voltage on the ADDR pin (V2), the set point should be the mid-point of the LSb of the ADC.

The examples in Figure 1-2 and Figure 1-3 show how to determine the mid point voltage (V2) and the range of voltages based on a voltage divider circuit. The maximum tolerance is 20%, however, it is recommended to use 5% tolerance worst case (10% total tolerance).

FIGURE 1-2: VOLTAGE DIVIDER EXAMPLE



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FIGURE 1-3: VOLTAGE AND CODE EXAMPLE

Assume:

$n = A2, A1, A0$ in opcode

ratio = $R2/(R1+R2)$

$V2$ = voltage on ADDR pin

$V2(\text{min}) = V2 - (VDD/8) \times \% \text{tolerance}$

$V2(\text{max}) = V2 + (VDD/8) \times \% \text{tolerance}$

| VDD= 1.8 | | | | | 10% Tolerance (total) | |
|----------|---------|----------|------------|--------------|-----------------------|---------|
| n | R2=2n+1 | R1=16-R2 | R2/(R1+R2) | V2 | V2(min) | V2(max) |
| 0 | 1 | 15 | 0.0625 | 0.113 | 0.00 | 0.14 |
| 1 | 3 | 13 | 0.1875 | 0.338 | 0.32 | 0.36 |
| 2 | 5 | 11 | 0.3125 | 0.563 | 0.54 | 0.59 |
| 3 | 7 | 9 | 0.4375 | 0.788 | 0.77 | 0.81 |
| 4 | 9 | 7 | 0.5625 | 1.013 | 0.99 | 1.04 |
| 5 | 11 | 5 | 0.6875 | 1.238 | 1.22 | 1.26 |
| 6 | 13 | 3 | 0.8125 | 1.463 | 1.44 | 1.49 |
| 7 | 15 | 1 | 0.9375 | 1.688 | 1.67 | 1.80 |

| VDD= 2.7 | | | | | 10% Tolerance (total) | |
|----------|---------|----------|------------|--------------|-----------------------|---------|
| n | R2=2n+1 | R1=16-R2 | R2/(R1+R2) | V2 | V2(min) | V2(max) |
| 0 | 1 | 15 | 0.0625 | 0.169 | 0.00 | 0.19 |
| 1 | 3 | 13 | 0.1875 | 0.506 | 0.48 | 0.53 |
| 2 | 5 | 11 | 0.3125 | 0.844 | 0.82 | 0.87 |
| 3 | 7 | 9 | 0.4375 | 1.181 | 1.16 | 1.20 |
| 4 | 9 | 7 | 0.5625 | 1.519 | 1.50 | 1.54 |
| 5 | 11 | 5 | 0.6875 | 1.856 | 1.83 | 1.88 |
| 6 | 13 | 3 | 0.8125 | 2.194 | 2.17 | 2.22 |
| 7 | 15 | 1 | 0.9375 | 2.531 | 2.51 | 2.70 |

| VDD= 3.3 | | | | | 10% Tolerance (total) | |
|----------|---------|----------|------------|--------------|-----------------------|---------|
| n | R2=2n+1 | R1=16-R2 | R2/(R1+R2) | V2 | V2(min) | V2(max) |
| 0 | 1 | 15 | 0.0625 | 0.206 | 0.00 | 0.23 |
| 1 | 3 | 13 | 0.1875 | 0.619 | 0.60 | 0.64 |
| 2 | 5 | 11 | 0.3125 | 1.031 | 1.01 | 1.05 |
| 3 | 7 | 9 | 0.4375 | 1.444 | 1.42 | 1.47 |
| 4 | 9 | 7 | 0.5625 | 1.856 | 1.83 | 1.88 |
| 5 | 11 | 5 | 0.6875 | 2.269 | 2.25 | 2.29 |
| 6 | 13 | 3 | 0.8125 | 2.681 | 2.66 | 2.70 |
| 7 | 15 | 1 | 0.9375 | 3.094 | 3.07 | 3.30 |

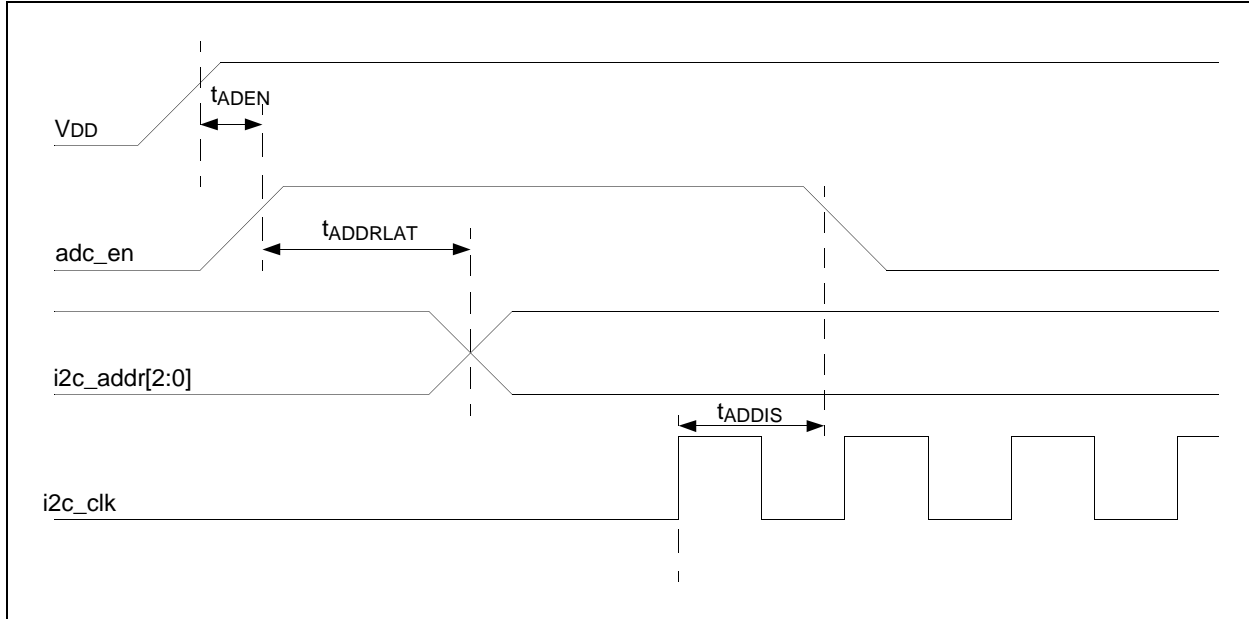
| VDD= 5.5 | | | | | 10% Tolerance (total) | |
|----------|---------|----------|------------|--------------|-----------------------|---------|
| n | R2=2n+1 | R1=16-R2 | R2/(R1+R2) | V2 | V2(min) | V2(max) |
| 0 | 1 | 15 | 0.0625 | 0.344 | 0.00 | 0.37 |
| 1 | 3 | 13 | 0.1875 | 1.031 | 1.01 | 1.05 |
| 2 | 5 | 11 | 0.3125 | 1.719 | 1.70 | 1.74 |
| 3 | 7 | 9 | 0.4375 | 2.406 | 2.38 | 2.43 |
| 4 | 9 | 7 | 0.5625 | 3.094 | 3.07 | 3.12 |
| 5 | 11 | 5 | 0.6875 | 3.781 | 3.76 | 3.80 |
| 6 | 13 | 3 | 0.8125 | 4.469 | 4.45 | 4.49 |
| 7 | 15 | 1 | 0.9375 | 5.156 | 5.13 | 5.50 |

FIGURE 1-4: FLASH ADC BLOCK DIAGRAM



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FIGURE 1-5: HARDWARE ADDRESS DECODE TIMING



1.4.2 ADDRESSING I²C DEVICES (MCP23009)

The MCP23009 is a slave I²C device that supports 7-bit slave addressing, with the read/write bit filling out the control byte. The slave address contains four fixed bits and three user-defined hardware address bits (configured via ADDR pin). [Figure 1-6](#) shows the control byte format.

1.4.3 ADDRESSING SPI DEVICES (MCP23S09)

The MCP23S09 is a slave SPI device. The slave address contains seven fixed bits (no address bits) with the read/write bit filling out the control byte. [Figure 1-7](#) shows the control byte format.

FIGURE 1-6: I²C™ CONTROL BYTE FORMAT

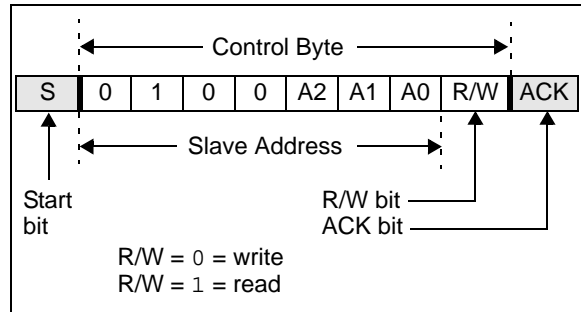


FIGURE 1-7: SPI CONTROL BYTE FORMAT



FIGURE 1-8: I²C™ ADDRESSING REGISTERS



FIGURE 1-9: SPI ADDRESSING REGISTERS



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1.5 GPIO Port

The GPIO module is a general purpose 8-bit wide bidirectional port.

The outputs are open-drain.

The GPIO module contains the data ports (GPIO_n), internal pull up resistors and the Output Latches (OLAT_n).

The pull up resistors are individually configured and can be enabled when the pin is configured as an input or output.

Reading the GPIO_n register reads the value on the port. Reading the OLAT_n register only reads the latches, not the actual value on the port.

Writing to the GPIO_n register actually causes a write to the latches (OLAT_n). Writing to the OLAT_n register forces the associated output drivers to drive to the level in OLAT_n. Pins configured as inputs turn off the associated output driver and put it in high-impedance.

1.6 Configuration and Control Registers

There are eleven (11) registers associated with the MCP23X09 as shown in [Table 1-4](#).

TABLE 1-4: CONFIGURATION AND CONTROL REGISTER

| Register Name | Address (hex) | bit 7 | bit 6 | bit 5 | bit 4 | bit 3 | bit 2 | bit 1 | bit 0 | POR/RST value |
|---------------|---------------|--------|--------|--------|--------|--------|--------|--------|--------|---------------|
| IODIRA | 00 | IO7 | IO6 | IO5 | IO4 | IO3 | IO2 | IO1 | IO0 | 1111 1111 |
| IPOLA | 01 | IP7 | IP6 | IP5 | IP4 | IP3 | IP2 | IP1 | IP0 | 0000 0000 |
| GPINTENA | 02 | GPINT7 | GPINT6 | GPINT5 | GPINT4 | GPINT3 | GPINT2 | GPINT1 | GPINT0 | 0000 0000 |
| DEFVALA | 03 | DEF7 | DEF6 | DEF5 | DEF4 | DEF3 | DEF2 | DEF1 | DEF0 | 0000 0000 |
| INTCONA | 04 | IOC7 | IOC6 | IOC5 | IOC4 | IOC3 | IOC2 | IOC1 | IOC0 | 0000 0000 |
| IOCON | 05 | — | — | SEQOP | — | — | ODR | INTPOL | INTCC | 0000 0000 |
| GPPUA | 06 | PU7 | PU6 | PU5 | PU4 | PU3 | PU2 | PU1 | PU0 | 0000 0000 |
| INTFA | 07 | INT7 | INT6 | INT5 | INT4 | INT3 | INT2 | INT1 | INT0 | 0000 0000 |
| INTCAPA | 08 | ICP7 | ICP6 | ICP5 | ICP4 | ICP3 | ICP2 | ICP1 | ICP0 | 0000 0000 |
| GPIOA | 09 | GP7 | GP6 | GP5 | GP4 | GP3 | GP2 | GP1 | GP0 | 0000 0000 |
| OLATA | 0A | OL7 | OL6 | OL5 | OL4 | OL3 | OL2 | OL1 | OL0 | 0000 0000 |

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1.6.1 I/O DIRECTION REGISTER

Controls the direction of the data I/O.

When a bit is set, the corresponding pin becomes an input. When a bit is clear, the corresponding pin becomes an output.

REGISTER 1-1: IODIR – I/O DIRECTION REGISTER

| R/W-1 | R/W-1 | R/W-1 | R/W-1 | R/W-1 | R/W-1 | R/W-1 | R/W-1 |
|-------|-------|-------|-------|-------|-------|-------|-------|
| IO7 | IO6 | IO5 | IO4 | IO3 | IO2 | IO1 | IO0 |
| bit 7 | | | | | | | bit 0 |

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 7-0 **IO7:IO0:** Controls the direction of data I/O <7:0>

1 = Pin is configured as an input

0 = Pin is configured as an output

1.6.2 INPUT POLARITY REGISTER

This register allows the user to configure the polarity on the corresponding GPIO port bits.

If a bit is set, the corresponding GPIO register bit will reflect the inverted value on the pin.

REGISTER 1-2: IPOL – INPUT POLARITY PORT REGISTER

| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|-------|-------|-------|-------|-------|-------|-------|-------|
| IP7 | IP6 | IP5 | IP4 | IP3 | IP2 | IP1 | IP0 |
| bit 7 | | | | | | | bit 0 |

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 7-0

IP7:IP0: Controls the polarity inversion of the input pins <7:0>

1 = GPIO register bit will reflect the opposite logic state of the input pin

0 = GPIO register bit will reflect the same logic state of the input pin

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1.6.3 INTERRUPT-ON-CHANGE CONTROL REGISTER

The GPINTEN register controls the interrupt-on-change feature for each pin.

If a bit is set, the corresponding pin is enabled for interrupt-on-change. The DEFVAL and INTCON registers must also be configured if any pins are enabled for interrupt-on-change.

REGISTER 1-3: GPINTEN – INTERRUPT-ON-CHANGE PINS

| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|--------|--------|--------|--------|--------|--------|--------|--------|
| GPINT7 | GPINT6 | GPINT5 | GPINT4 | GPINT3 | GPINT2 | GPINT1 | GPINT0 |
| bit 7 | | | | | | | bit 0 |

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 7-0 **GPINT7:GPINT0:** General purpose I/O interrupt-on-change pins <7:0>

1 = Enable GPIO input pin for interrupt-on-change event

0 = Disable GPIO input pin for interrupt-on-change event

Refer to INTCON and DEFVAL.

1.6.4 DEFAULT COMPARE REGISTER FOR INTERRUPT-ON-CHANGE

The default comparison value is configured in the DEFVAL register. If enabled (via GPINTEN and INTCON) to compare against the DEFVAL register, an opposite value on the associated pin will cause an interrupt to occur.

REGISTER 1-4: DEFVAL – DEFAULT VALUE REGISTER

| | | | | | | | |
|-------|-------|-------|-------|-------|-------|-------|-------|
| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
| DEF7 | DEF6 | DEF5 | DEF4 | DEF3 | DEF2 | DEF1 | DEF0 |
| bit 7 | | | | | | | bit 0 |

Legend:

| | | |
|-------------------|------------------|--|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared x = Bit is unknown |

bit 7-0 **DEF7:DEF0:** Sets the compare value for pins configured for interrupt-on-change from defaults <7:0>. Refer to INTCON.
 If the associated pin level is the opposite from the register bit, an interrupt occurs.
 Refer to INTCON and GPINTEN.

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1.6.5 INTERRUPT CONTROL REGISTER

The INTCON register controls how the associated pin value is compared for the interrupt-on-change feature. If a bit is set, the corresponding I/O pin is compared against the associated bit in the DEFVAL register. If a bit value is clear, the corresponding I/O pin is compared against the previous value.

REGISTER 1-5: INTCON – INTERRUPT-ON-CHANGE CONTROL REGISTER

| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|-------|-------|-------|-------|-------|-------|-------|-------|
| IOC7 | IOC6 | IOC5 | IOC4 | IOC3 | IOC2 | IOC1 | IOC0 |
| bit 7 | | | | | | | bit 0 |

| | | | |
|-------------------|------------------|------------------------------------|--------------------|
| Legend: | | | |
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 7-0 **IOC7:IOC0:** Controls how the associated pin value is compared for interrupt-on-change <7:0>.
1 = Pin value is compared against the associated bit in DEFVAL register
0 = Pin value is compared against the previous pin value

Refer to DEFVAL and GPINTEN.

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1.6.6 CONFIGURATION REGISTER

The Sequential Operation (**SEQOP**) controls the incrementing function of the address pointer. If the address pointer is disabled, the address pointer does not automatically increment after each byte is clocked during a serial transfer. This feature is useful when it is desired to continuously poll (read) or modify (write) a register.

The Open-Drain (**ODR**) control bit enables/disables the INT pin for open-drain configuration.

The Interrupt Polarity (**INTPOL**) sets the polarity of the INT pin. This bit is functional only when the ODR bit is cleared, configuring the INT pin as active push-pull.

The Interrupt Clearing Control (**INTCC**) configures how interrupts are cleared. When set (INTCC = 1), the interrupt is cleared when the INTCAP register is read. When cleared (INTCC = 0), the interrupt is cleared when the GPIO register is read.

The interrupt can only be cleared when the interrupt condition is inactive. Refer to **Section 1.7.4 “Clearing Interrupts”** for details.

REGISTER 1-6: IOCON – I/O EXPANDER CONFIGURATION REGISTER

| | | | | | | | |
|-------|-----|-------|-----|-----|-------|--------|-------|
| U-0 | U-0 | R/W-0 | U-0 | U-0 | R/W-0 | R/W-0 | R/W-0 |
| - | - | SEQOP | - | - | ODR | INTPOL | INTCC |
| bit 7 | | | | | | | bit 0 |

Legend:

| | | |
|-------------------|------------------|------------------------------------|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared |
| | | x = Bit is unknown |

- bit 7 **Unimplemented:** Reads as 0
- bit 6 **Unimplemented:** Reads as 0
- bit 5 **SEQOP:** Sequential Operation mode bit.
1 = Sequential operation disabled, address pointer does not increment
0 = Sequential operation enabled, address pointer increments
- bit 4 **Unimplemented:** Reads as 0
- bit 3 **Unimplemented:** Reads as 0
- bit 2 **ODR:** Configures the INT pin as an open-drain output.
1 = Open-drain output (overrides the INTPOL bit)
0 = Active driver output (INTPOL bit sets the polarity)
- bit 1 **INTPOL:** Sets the polarity of the INT output pin.
1 = Active-high
0 = Active-low
- bit 0 **INTCC:** Interrupt Clearing Control
1 = Reading INTCAP register clears the interrupt
0 = Reading GPIO register clears the interrupt

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1.6.7 PULL-UP RESISTOR CONFIGURATION REGISTER

The GPPU register controls the pull-up resistors for the port pins. If a bit is set the corresponding port pin is internally pulled up with an internal resistor.

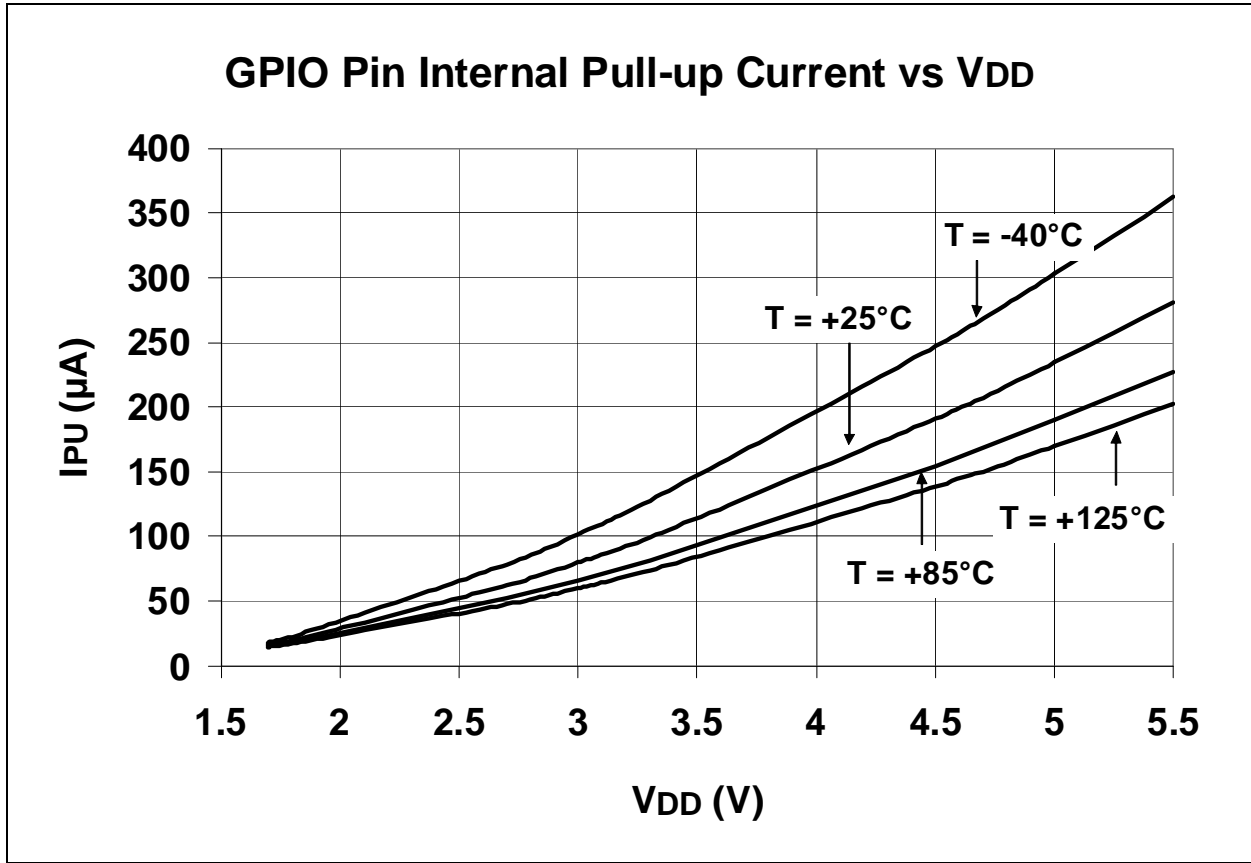
REGISTER 1-7: GPPU – GPIO PULL-UP RESISTOR REGISTER

| | | | | | | | |
|-------|-------|-------|-------|-------|-------|-------|-------|
| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
| PU7 | PU6 | PU5 | PU4 | PU3 | PU2 | PU1 | PU0 |
| bit 7 | | | | | | | bit 0 |

| | | | |
|-------------------|------------------|------------------------------------|--------------------|
| Legend: | | | |
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 7-0 **PU7:PU0:** Controls the internal pull-up resistors on each pin (when configured as an input or output) <7:0>.
 1 = Pull-up enabled
 0 = Pull-up disabled

FIGURE 1-10: TYPICAL PERFORMANCE CURVE FOR THE INTERNAL PULL-UP RESISTORS



1.6.8 INTERRUPT FLAG REGISTER

The INTF register reflects the interrupt condition on the port pins of any pin that is enabled for interrupts via the GPINTEN register. A 'set' bit indicates that the associated pin caused the interrupt.

This register is 'read only'. Writes to this register will be ignored.

REGISTER 1-8: INTF – INTERRUPT FLAG REGISTER

| | | | | | | | |
|-------|------|------|------|------|------|------|-------|
| R-0 | R-0 | R-0 | R-0 | R-0 | R-0 | R-0 | R-0 |
| INT7 | INT6 | INT5 | INT4 | INT3 | INT2 | INT1 | INT0 |
| bit 7 | | | | | | | bit 0 |

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 7-0

INT7:INT0: Reflects the interrupt condition on the port. Will reflect the change only if interrupts are enabled (GPINTEN) <7:0>.

1 = Pin caused interrupt

0 = Interrupt not pending

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1.6.9 INTERRUPT CAPTURE REGISTER

The INTCAP register captures the GPIO port value at the time the interrupt occurred. The register is 'read only' and is updated only when an interrupt occurs. The register will remain unchanged until the interrupt is cleared via a read of INTCAP or GPIO.

REGISTER 1-9: INTCAP – INTERRUPT CAPTURED VALUE FOR PORT REGISTER

| R-x | R-x | R-x | R-x | R-x | R-x | R-x | R-x |
|-------|------|------|------|------|------|------|-------|
| ICP7 | ICP6 | ICP5 | ICP4 | ICP3 | ICP2 | ICP1 | ICP0 |
| bit 7 | | | | | | | bit 0 |

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 7-0

ICP7:ICP0: Reflects the logic level on the port pins at the time of interrupt due to pin change <7:0>.

1 = Logic-high

0 = Logic-low

1.6.10 PORT REGISTER

The GPIO register reflects the value on the port. Reading from this register reads the port. Writing to this register modifies the Output Latch (OLAT) register.

REGISTER 1-10: GPIO – GENERAL PURPOSE I/O PORT REGISTER

| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|-------|-------|-------|-------|-------|-------|-------|-------|
| GP7 | GP6 | GP5 | GP4 | GP3 | GP2 | GP1 | GP0 |
| bit 7 | | | | | | | bit 0 |

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 7-0

GP7:GP0: Reflects the logic level on the pins <7:0>.

1 = Logic-high

0 = Logic-low

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1.6.11 OUTPUT LATCH REGISTER (OLAT)

The OLAT register provides access to the output latches. A read from this register results in a read of the OLAT and not the port itself. A write to this register modifies the output latches that modifies the pins configured as outputs.

REGISTER 1-11: OLAT – OUTPUT LATCH REGISTER 0

| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|-------|-------|-------|-------|-------|-------|-------|-------|
| OL7 | OL6 | OL5 | OL4 | OL3 | OL2 | OL1 | OL0 |
| bit 7 | | | | | | | bit 0 |

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 7-0

OL7:OL0: Reflects the logic level on the output latch <7:0>.

1 = Logic-high

0 = Logic-low

1.7 Interrupt Logic

If enabled, the MCP23X09 activates the INT interrupt output when one of the port pins changes state or when a pin does not match the pre-configured default. Each pin is individually configurable as follows:

- Enable/disable interrupt via GPINTEN
- Can interrupt on either pin change or change from default as configured in DEFVAL

Both conditions are referred to as Interrupt on Change (IOC).

The Interrupt Control Module uses the following registers/bits:

- GPINTEN - Interrupt enable register
- INTCON - Controls the source for the IOC
- DEFVAL - Contains the register default for IOC operation
- IOCON (ODR and INTPOL) - configures the INT pin as push-pull, open-drain, and active level (high or low).

1.7.1 IOC FROM PIN CHANGE

If enabled, the MCP23X09 will generate an interrupt if a mismatch condition exists between the current port value and the previous port value. Only IOC enabled pins will be compared. See GPINTEN and INTCON registers.

1.7.2 IOC FROM REGISTER DEFAULT

If enabled, the MCP23X09 will generate an interrupt if a mismatch occurs between the DEFVAL register and the port. Only IOC enabled pins will be compared. See GPINTEN, INTCON, and DEFVAL registers.

1.7.3 INTERRUPT OPERATION

The INT interrupt output can be configured as “active low”, “active high”, or “open-drain” via the IOCON register.

Only those pins that are configured as an input (IODIR register) with interrupt-on-change (IOC) enabled (GPINTEN register) can cause an interrupt. Pins configured as an output have no effect on the interrupt output pin.

Input change activity on a port input pin that is enabled for IOC will generate an internal device interrupt and the device will capture the value of the port and copy it into INTCAP.

The first interrupt event will cause the port contents to be copied into the INTCAP register. Subsequent interrupt conditions on the port will not cause an interrupt to occur as long as the interrupt is not cleared by a read of INTCAP or GPIO.

1.7.4 CLEARING INTERRUPTS

The interrupt will remain active until the INTCAP or GPIO register is read (depending on IOCON.INTCC). Writing to these registers will not affect the interrupt. The interrupt condition will be cleared after the LSB of the data is clocked out during a Read operation of GPIO or INTCAP (depending on IOCON.INTCC).

Note: Assuming IOCON.INTCC = 0 (INT cleared on GPIO read): The value in INTCAP can be lost if GPIO is read before INTCAP while another IOC is pending. After reading GPIO, the interrupt will clear and then set due to the pending IOC, causing the INTCAP register to update.

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1.7.5 INTERRUPT CONDITIONS

There are two possible configurations to cause interrupts (configured via INTCON):

1. Pins configured for **interrupt-on-pin-change** will cause an interrupt to occur if a pin changes to the opposite state. The default state is reset after an interrupt occurs. For example, an interrupt occurs by an input changing from 1 to 0. The new initial state for the pin is a logic 0.
2. Pins configured for **interrupt-on-change from register value** will cause an interrupt to occur if the corresponding input pin differs from the register bit. The interrupt condition will remain as long as the condition exists, regardless if the INTAP or GPIO is read.

See [Figure 1-11](#) and [Figure 1-12](#) for more information on interrupt operations.

FIGURE 1-11: INTERRUPT-ON-PIN-CHANGE

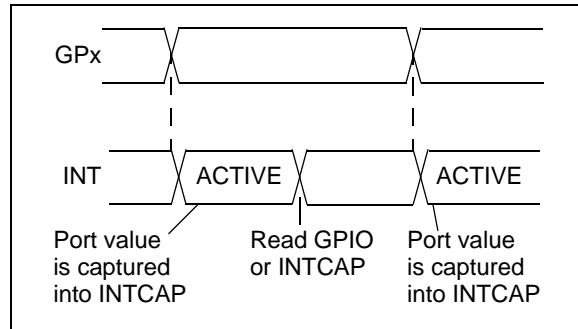
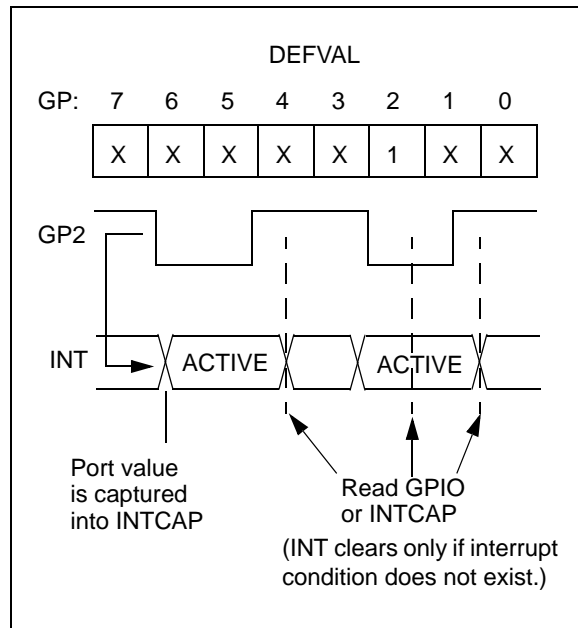


FIGURE 1-12: INTERRUPT-ON-CHANGE FROM REGISTER DEFAULT



2.0 ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings (†)

| | |
|--|-----------------------|
| Ambient temperature under bias | -40°C to +125°C |
| Storage temperature | -65°C to +150°C |
| Voltage on VDD with respect to VSS | -0.3V to +7.0V |
| Voltage on $\overline{\text{RESET}}$ with respect to VSS | -0.3V to +14V |
| Voltage on all other pins with respect to VSS (except VDD and GPIOA/B) | -0.6V to (VDD + 0.6V) |
| Voltage on GPIO Pins: | -0.6V to 5.5V |
| Total power dissipation (Note 1)..... | 700 mW |
| Maximum current out of VSS pin | 200 mA |
| Maximum current into VDD pin | 125 mA |
| Input clamp current, I _{IK} (V _I < 0 or V _I > VDD)..... | ±20 mA |
| Output clamp current, I _{OK} (V _O < 0 or V _O > VDD) | ±20 mA |
| Maximum output current sunk by any Output pin..... | 25 mA |
| Maximum output current sunk by any Output pin (VDD = 1.8V) | 10 mA |

Note: Power dissipation is calculated as follows:
 $P_{dis} = VDD \times \{I_{DD} - \sum I_{OH}\} + \sum \{(VDD - V_{OH}) \times I_{OH}\} + \sum (V_{OL} \times I_{OL})$

† **NOTICE:** Stresses above those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

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2.1 DC CHARACTERISTICS

| DC Characteristics | | Operating Conditions (unless otherwise indicated): 1.8V ≤ VDD ≤ 5.5V at -40°C ≤ TA ≤ +125°C | | | | | |
|--|--|--|-----------|--------------------|---------|-------|--|
| Param No. | Characteristic | Sym | Min | Typ ⁽²⁾ | Max | Units | Conditions |
| D001 | Supply Voltage | VDD | 1.8 | — | 5.5 | V | |
| D002 | VDD Start Voltage to Ensure Power-on Reset | VPOR | — | VSS | — | V | |
| D003 | VDD Rise Rate to Ensure Power-on Reset | SVDD | 0.05 | — | — | V/ms | Design guidance only. Not tested. |
| D004 | Supply Current | IDD | — | — | 1 | mA | SCL/SCK = 1 MHz |
| D005 | Standby (Idle) current | IDDS | — | — | 1 | μA | -40°C ≤ TA ≤ +85°C |
| | | | — | — | 6 | μA | +85°C ≤ TA ≤ +125°C |
| Input Low-Voltage | | | | | | | |
| D031 | $\overline{\text{CS}}$, GPIO, SCL/SCK, SDA, SI, RESET | VIL | VSS | — | 0.2 VDD | V | |
| Input High-Voltage | | | | | | | |
| D041 | $\overline{\text{CS}}$, SCL/SCK, SDA, SI, RESET | VIH | 0.8 VDD | — | VDD | V | |
| | GPIO | VIH | 0.8 VDD | — | 5.5 | V | |
| Input Leakage Current | | | | | | | |
| D060 | I/O port pins | IIL | — | — | ±1 | μA | VSS ≤ VPIN ≤ VDD, |
| Output Leakage Current | | | | | | | |
| D065 | I/O port pins | ILO | — | — | ±1 | μA | VSS ≤ VPIN ≤ VDD, |
| D070 | GPIO internal pull-up current | IPU | — | 220 | — | μA | VDD = 5V, GP Pins = VSS Note 1 |
| Output Low-Voltage | | | | | | | |
| D080 | GPIO | VOL | — | — | 0.6 | V | IOL = 8.5 mA, VDD = 4.5V (open-drain) |
| | INT | | — | — | 0.6 | V | IOL = 1.6 mA, VDD = 4.5V |
| | SO, SDA | | — | — | 0.6 | V | IOL = 3.0 mA, VDD = 1.8V |
| | SDA | | — | — | 0.8 | V | IOL = 3.0 mA, VDD = 4.5V |
| Output High-Voltage | | | | | | | |
| D090 | INT, SO | VOH | VDD - 0.7 | — | — | V | IOH = -3.0 mA, VDD = 4.5V |
| | | | VDD - 0.7 | — | — | | IOH = -400 μA, VDD = 1.8V |
| Capacitive Loading Specs on Output Pins | | | | | | | |
| D101 | GPIO, SO, INT | CIO | — | — | 50 | pF | |
| D102 | SDA | CB | — | — | 400 | pF | |

Note 1: This parameter is characterized, not 100% tested.

2: Data in the Typical ("Typ") column is at 5V, +25°C unless otherwise stated.

2.2 AC CHARACTERISTICS

FIGURE 2-1: LOAD CONDITIONS FOR DEVICE TIMING SPECIFICATIONS



FIGURE 2-2: RESET AND DEVICE RESET TIMER TIMING



TABLE 2-1: RESET AND DEVICE RESET TIMER REQUIREMENTS

| AC Characteristics Standard Operating Conditions (unless otherwise specified) 1.8V ≤ VDD ≤ 5.5V at -40°C ≤ TA ≤ +125°C. | | | | | | | |
|--|-------|------------------------------------|-----|--------------------|-----|-------|------------|
| Parameter No. | Sym | Characteristic | Min | Typ ⁽²⁾ | Max | Units | Conditions |
| 30 | TRSTL | RESET Pulse Width (low) | 1 | — | — | μs | VDD = 5.0V |
| 32 | THLD | Device active after reset high | — | 0 | — | μs | VDD = 5.0V |
| 31 | TPOR | POR at device power up | — | 20 | — | μs | VDD = 5.0V |
| 34 | Tioz | Output Hi-impedance from RESET Low | — | — | 1 | μs | |

Note 1: This parameter is characterized, not 100% tested.

2: Data in the Typical ("Typ") column is at 5V, +25°C, unless otherwise stated.

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TABLE 2-2: GP AND INT PINS

| AC Characteristics Standard Operating Conditions (unless otherwise specified) 1.8V ≤ VDD ≤ 5.5V at -40°C ≤ TA ≤ +125°C. | | | | | | | |
|--|---------|-----------------------------------|-----|--------------------|-----|-------|---------------|
| Parameter No. | Sym | Characteristic | Min | Typ ⁽²⁾ | Max | Units | Conditions |
| 50 | tGPOV | Serial data to output valid | — | — | 500 | ns | |
| 51 | tINTD | Interrupt pin disable time | — | — | 600 | ns | |
| 52 | tGPIV | GP input change to register valid | — | 450 | — | ns | Note 1 |
| 53 | tGPINT | IOC event to INT active | — | — | 600 | ns | |
| 54 | tGLITCH | Glitch filter on GP pins | — | — | 50 | ns | Note 1 |

Note 1: This parameter is characterized, not 100% tested.

2: Data in the Typical ("Typ") column is at 5V, +25°C, unless otherwise stated.

FIGURE 2-3: GPIO AND INT TIMING



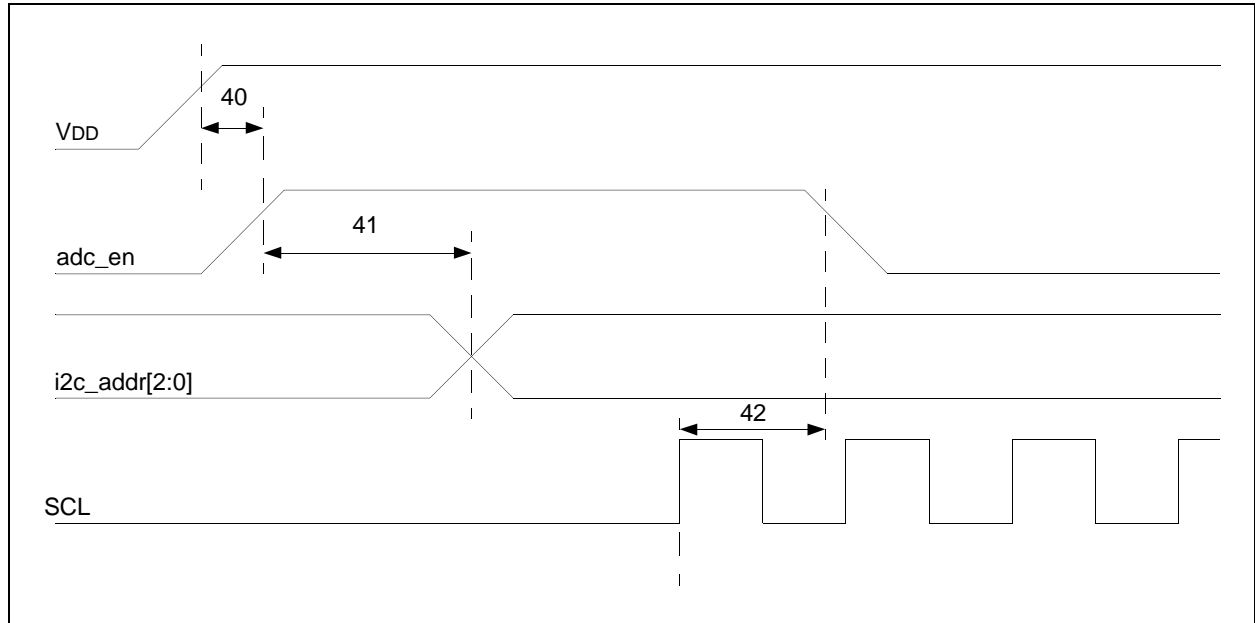
TABLE 2-3: HARDWARE ADDRESS LATCH TIMING

| AC Characteristics Standard Operating Conditions (unless otherwise specified) 1.8V ≤ VDD ≤ 5.5V at -40°C ≤ TA ≤ +125°C. | | | | | | | |
|--|----------|---|-----|--------------------|-----|-------|------------|
| Parameter No. | Sym | Characteristic | Min | Typ ⁽²⁾ | Max | Units | Conditions |
| 40 | tADEN | Time from VDD stable after POR to ADC enable | — | 0 | — | μs | Note 1 |
| 41 | tADDRLAT | Time from ADC enable to address decode and latch | — | 50 | — | ns | Note 1 |
| 42 | tADDIS | Time from raising edge of serial clock to ADC disable | — | 10 | — | ns | Note 1 |

Note 1: This parameter is characterized, not 100% tested.

Note 2: Data in the Typical (“Typ”) column is at 5V, +25°C, unless otherwise stated..

FIGURE 2-4: HARDWARE ADDRESS LATCH TIMING



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FIGURE 2-5: I²C BUS START/STOP BITS TIMING



FIGURE 2-6: I²C BUS DATA TIMING



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TABLE 2-4: I²C BUS DATA REQUIREMENTS (SLAVE MODE)

| I ² C™ AC Characteristics | | Operating Conditions (unless otherwise indicated): 1.8V ≤ V _{DD} ≤ 5.5V at -40°C ≤ T _A ≤ +125°C R _{PU} (SCL, SDA) = 1 kΩ, C _L (SCL, SDA) = 135 pF. | | | | | |
|--------------------------------------|-----------------------------|--|--|-----|------|-------|-------------|
| Param No. | Characteristic | Sym | Min | Typ | Max | Units | Conditions |
| 100 | Clock High Time: | T _{HIGH} | | | | | |
| | 100 kHz mode | | 4.0 | — | — | μs | 1.8V – 5.5V |
| | 400 kHz mode | | 0.6 | — | — | μs | 1.8V – 5.5V |
| | 3.4 MHz mode | | 0.06 | — | — | μs | 2.7V – 5.5V |
| 101 | Clock Low Time: | T _{LOW} | | | | | |
| | 100 kHz mode | | 4.7 | — | — | μs | 1.8V – 5.5V |
| | 400 kHz mode | | 1.3 | — | — | μs | 1.8V – 5.5V |
| | 3.4 MHz mode | | 0.16 | — | — | μs | 2.7V – 5.5V |
| 102 | SDA and SCL Rise Time: | T _R (Note 1) | | | | | |
| | 100 kHz mode | | — | — | 1000 | ns | 1.8V – 5.5V |
| | 400 kHz mode | | 20 + 0.1 C _B ⁽²⁾ | — | 300 | ns | 1.8V – 5.5V |
| | 3.4 MHz mode | | 10 | — | 80 | ns | 2.7V – 5.5V |
| 103 | SDA and SCL Fall Time: | T _F (Note 1) | | | | | |
| | 100 kHz mode | | — | — | 300 | ns | 1.8V – 5.5V |
| | 400 kHz mode | | 20 + 0.1 C _B ⁽²⁾ | — | 300 | ns | 1.8V – 5.5V |
| | 3.4 MHz mode | | 10 | — | 80 | ns | 2.7V – 5.5V |
| 90 | START Condition Setup Time: | TSU:STA | | | | | |
| | 100 kHz mode | | 4.7 | — | — | μs | 1.8V – 5.5V |
| | 400 kHz mode | | 0.6 | — | — | μs | 1.8V – 5.5V |
| | 3.4 MHz mode | | 0.16 | — | — | μs | 2.7V – 5.5V |
| 91 | START Condition Hold Time: | THD:STA | | | | | |
| | 100 kHz mode | | 4.0 | — | — | μs | 1.8V – 5.5V |
| | 400 kHz mode | | 0.6 | — | — | μs | 1.8V – 5.5V |
| | 3.4 MHz mode | | 0.16 | — | — | μs | 2.7V – 5.5V |
| 106 | Data Input Hold Time: | THD:DAT | | | | | |
| | 100 kHz mode | | 0 | — | 3.45 | μs | 1.8V – 5.5V |
| | 400 kHz mode | | 0 | — | 0.9 | μs | 1.8V – 5.5V |
| | 3.4 MHz mode | | 0 | — | 0.07 | μs | 2.7V – 5.5V |
| 107 | Data Input Setup Time: | TSU:DAT | | | | | |
| | 100 kHz mode | | 250 | — | — | ns | 1.8V – 5.5V |
| | 400 kHz mode | | 100 | — | — | ns | 1.8V – 5.5V |
| | 3.4 MHz mode | | 0.01 | — | — | μs | 2.7V – 5.5V |
| 92 | STOP Condition Setup Time: | TSU:STO | | | | | |
| | 100 kHz mode | | 4.0 | — | — | μs | 1.8V – 5.5V |
| | 400 kHz mode | | 0.6 | — | — | μs | 2.7V – 5.5V |
| | 3.4 MHz mode | | 0.16 | — | — | μs | 4.5V – 5.5V |

Note 1: This parameter is characterized, not 100% tested.

2: C_B is specified from 10 to 400 (pF).

3: This parameter is not applicable in high-speed mode (3.4 MHz).

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TABLE 2-4: I²C BUS DATA REQUIREMENTS (SLAVE MODE) (CONTINUED)

| I ² C™ AC Characteristics | | Operating Conditions (unless otherwise indicated): 1.8V ≤ VDD ≤ 5.5V at -40°C ≤ TA ≤ +125°C RPU (SCL, SDA) = 1 kΩ, CL (SCL, SDA) = 135 pF. | | | | | |
|--------------------------------------|---|--|-----|-----|------|-------|-------------|
| Param No. | Characteristic | Sym | Min | Typ | Max | Units | Conditions |
| 109 | Output Valid From Clock: | TAA | | | | | |
| | 100 kHz mode | | — | — | 3.45 | μs | 1.8V – 5.5V |
| | 400 kHz mode | | — | — | 0.9 | μs | 1.8V – 5.5V |
| | 3.4 MHz mode | | — | — | 0.18 | μs | 2.7V – 5.5V |
| 110 | Bus Free Time: | TBUF (NOTE 3) | | | | | |
| | 100 kHz mode | | 4.7 | — | — | μs | 1.8V – 5.5V |
| | 400 kHz mode | | 1.3 | — | — | μs | 1.8V – 5.5V |
| | 3.4 MHz mode | | N/A | — | N/A | μs | 2.7V – 5.5V |
| | Bus Capacitive Loading: | Cb (NOTE 2) | | | | | |
| | 100 kHz and 400 kHz | | — | — | 400 | pF | (Note 1) |
| | 3.4 MHz | | — | — | 100 | pF | (Note 1) |
| | Input Filter Spike Suppression: (SDA and SCL) | TSP | | | | | |
| | 100 kHz and 400 kHz | | — | — | 50 | ns | (Note 1) |
| | 3.4 MHz | | — | — | 10 | ns | (Note 1) |

- Note 1:** This parameter is characterized, not 100% tested.
Note 2: Cb is specified from 10 to 400 (pF).
Note 3: This parameter is not applicable in high-speed mode (3.4 MHz).

FIGURE 2-7: SPI INPUT TIMING

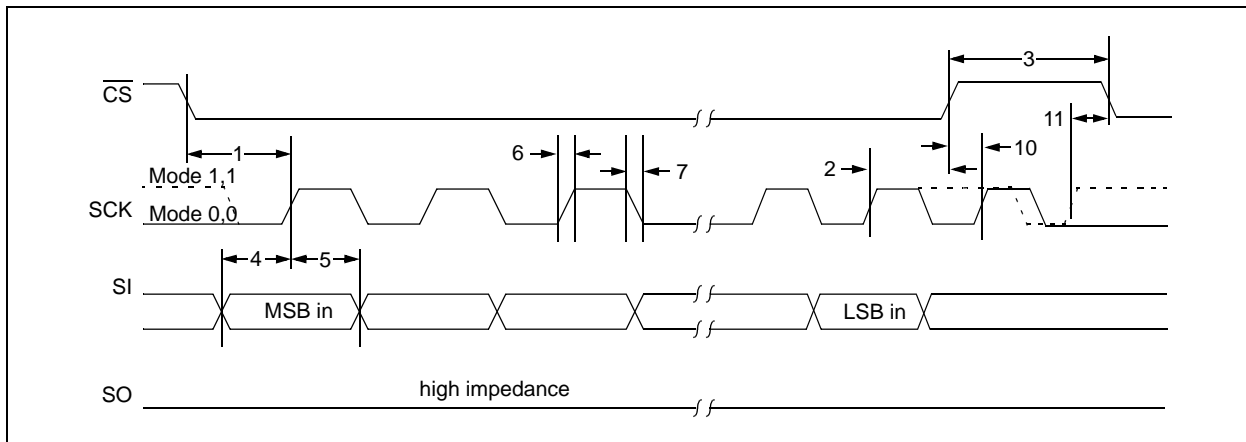


FIGURE 2-8: SPI OUTPUT TIMING



MCP23009/MCP23S09

TABLE 2-5: SPI INTERFACE AC CHARACTERISTICS

| SPI Interface AC Characteristics | | Operating Conditions (unless otherwise indicated): 1.8V ≤ VDD ≤ 5.5V at -40°C ≤ TA ≤ +125°C. | | | | | |
|----------------------------------|-----------------------------|---|-----|-----|-----|-------|---------------|
| Param No. | Characteristic | Sym | Min | Typ | Max | Units | Conditions |
| | Clock Frequency | FCLK | — | — | 10 | MHz | 1.8V – 5.5V |
| 1 | CS Setup Time | T _{CSS} | 50 | — | — | ns | |
| 2 | CS Hold Time | T _{CSH} | 50 | — | — | ns | 1.8V – 5.5V |
| 3 | CS Disable Time | T _{CSD} | 50 | — | — | ns | 1.8V – 5.5V |
| 4 | Data Setup Time | T _{SU} | 10 | — | — | ns | 1.8V – 5.5V |
| 5 | Data Hold Time | T _{HD} | 10 | — | — | ns | 1.8V – 5.5V |
| 6 | CLK Rise Time | T _R | — | — | 2 | μs | Note 1 |
| 7 | CLK Fall Time | T _F | — | — | 2 | μs | Note 1 |
| 8 | Clock High Time | T _{HI} | 45 | — | — | ns | 1.8V – 5.5V |
| 9 | Clock Low Time | T _{LO} | 45 | — | — | ns | 1.8V – 5.5V |
| 10 | Clock Delay Time | T _{C_{LD}} | 50 | — | — | ns | |
| 11 | Clock Enable Time | T _{CLE} | 50 | — | — | ns | |
| 12 | Output Valid from Clock Low | T _V | — | — | 45 | ns | 1.8V – 5.5V |
| 13 | Output Hold Time | T _{HO} | 0 | — | — | ns | |
| 14 | Output Disable Time | T _{DIS} | — | — | 100 | ns | |

Note 1: This parameter is characterized, not 100% tested.

FIGURE 2-9: TYPICAL PERFORMANCE CURVE FOR SPI TV SPECIFICATION (PARAM #12)



3.0 PACKAGING INFORMATION

3.1 Package Marking Information

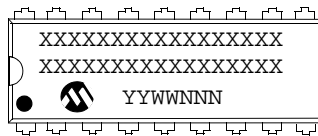
16-Lead QFN (3x3 mm)



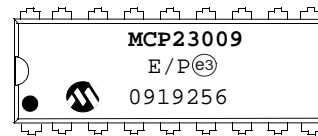
Example



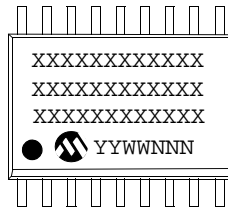
18-Lead PDIP (300 mil)



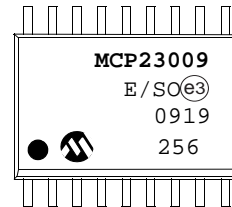
Example:



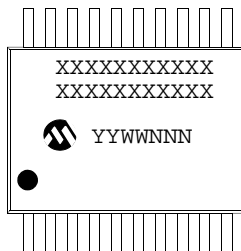
18-Lead SOIC (300 mil)



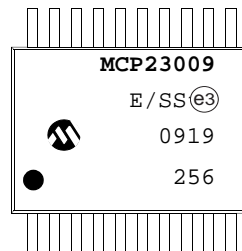
Example:



20-Lead SSOP (300 mil)



Example:



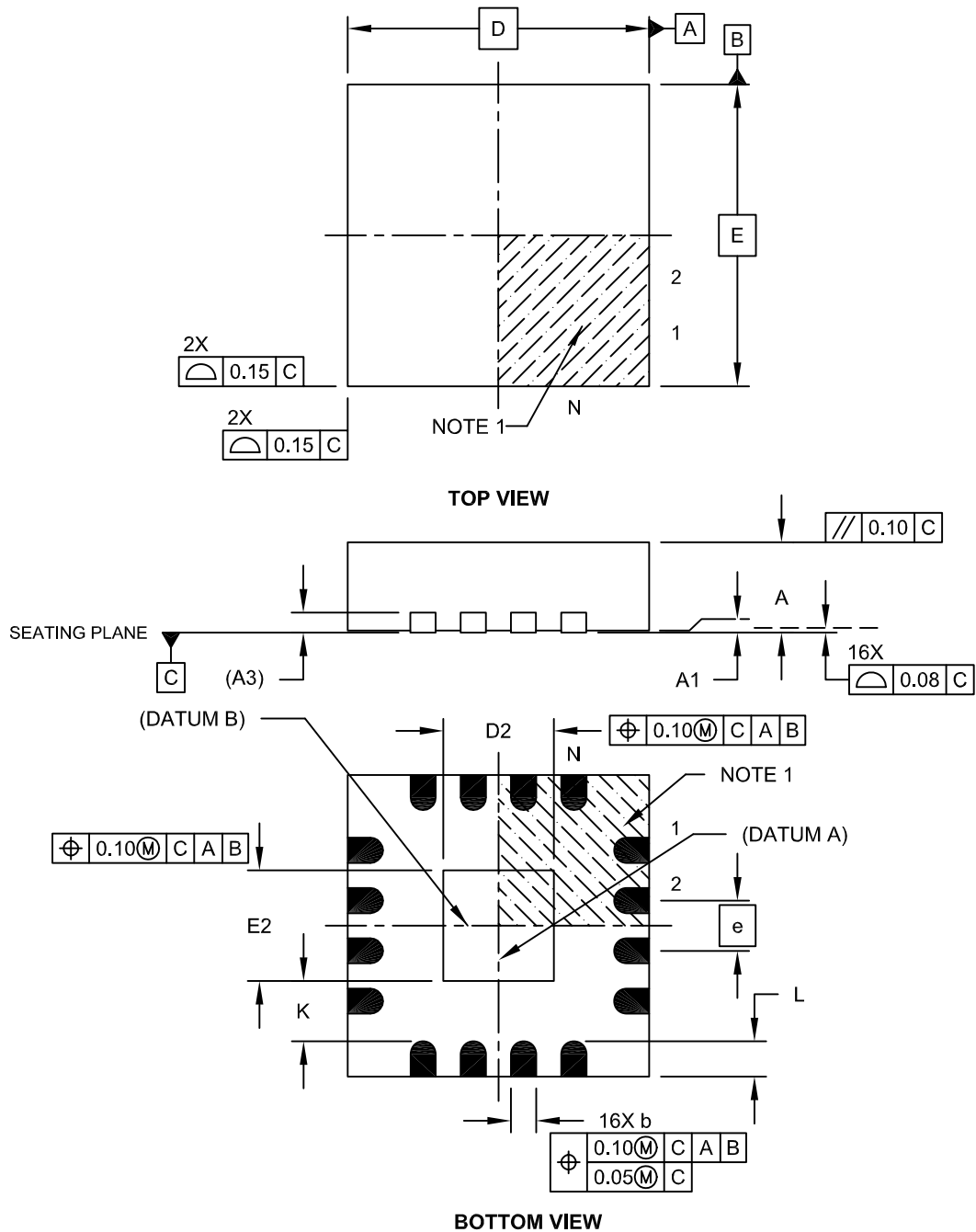
| | | |
|----------------|--------|--|
| Legend: | XX...X | Customer-specific information |
| | Y | Year code (last digit of calendar year) |
| | YY | Year code (last 2 digits of calendar year) |
| | WW | Week code (week of January 1 is week '01') |
| | NNN | Alphanumeric traceability code |
| | (e3) | Pb-free JEDEC designator for Matte Tin (Sn) |
| | * | This package is Pb-free. The Pb-free JEDEC designator (e3) can be found on the outer packaging for this package. |

Note: In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for customer-specific information.

MCP23009/MCP23S09

16-Lead Plastic Quad Flat, No Lead Package (MG) - 3x3x0.9 mm Body [QFN]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



Microchip Technology Drawing C04-142A Sheet 1 of 2

MCP23009/MCP23S09

16-Lead Plastic Quad Flat, No Lead Package (MG) - 3x3x0.9 mm Body [QFN]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



| Dimension Limits | Units | MILLIMETERS | | |
|------------------------|-------|-------------|------|------|
| | | MIN | NOM | MAX |
| Number of Pins | N | 16 | | |
| Pitch | e | 0.50 BSC | | |
| Overall Height | A | 0.80 | 0.85 | 0.90 |
| Standoff | A1 | 0.00 | 0.02 | 0.05 |
| Contact Thickness | A3 | 0.20 REF | | |
| Overall Width | E | 3.00 BSC | | |
| Exposed Pad Width | E2 | 1.00 | 1.10 | 1.50 |
| Overall Length | D | 3.00 BSC | | |
| Exposed Pad Length | D2 | 1.00 | 1.10 | 1.50 |
| Contact Width | b | 0.18 | 0.25 | 0.30 |
| Contact Length | L | 0.25 | 0.35 | 0.45 |
| Contact-to-Exposed Pad | K | 0.20 | - | - |

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. Package is saw singulated.
3. Dimensioning and tolerancing per ASME Y14.5M.
BSC: Basic Dimension. Theoretically exact value shown without tolerances.
REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-142A Sheet 2 of 2

MCP23009/MCP23S09

18-Lead Plastic Dual In-Line (P) – 300 mil Body [PDIP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



| Dimension Limits | Units | INCHES | | |
|----------------------------|-------|----------|------|------|
| | | MIN | NOM | MAX |
| Number of Pins | N | 18 | | |
| Pitch | e | .100 BSC | | |
| Top to Seating Plane | A | – | – | .210 |
| Molded Package Thickness | A2 | .115 | .130 | .195 |
| Base to Seating Plane | A1 | .015 | – | – |
| Shoulder to Shoulder Width | E | .300 | .310 | .325 |
| Molded Package Width | E1 | .240 | .250 | .280 |
| Overall Length | D | .880 | .900 | .920 |
| Tip to Seating Plane | L | .115 | .130 | .150 |
| Lead Thickness | c | .008 | .010 | .014 |
| Upper Lead Width | b1 | .045 | .060 | .070 |
| Lower Lead Width | b | .014 | .018 | .022 |
| Overall Row Spacing § | eB | – | – | .430 |

Notes:

- Pin 1 visual index feature may vary, but must be located within the hatched area.
- § Significant Characteristic.
- Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" per side.
- Dimensioning and tolerancing per ASME Y14.5M.

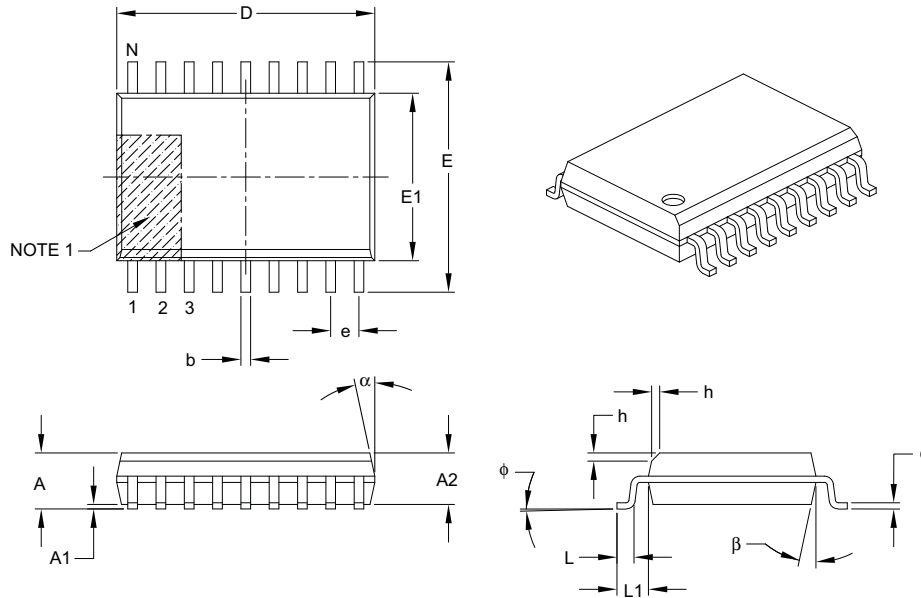
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing C04-007B

MCP23009/MCP23S09

18-Lead Plastic Small Outline (SO) – Wide, 7.50 mm Body [SOIC]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



| Dimension Limits | Units | MILLIMETERS | | |
|--------------------------|-------|-------------|-----|------|
| | | MIN | NOM | MAX |
| Number of Pins | N | 18 | | |
| Pitch | e | 1.27 BSC | | |
| Overall Height | A | – | – | 2.65 |
| Molded Package Thickness | A2 | 2.05 | – | – |
| Standoff § | A1 | 0.10 | – | 0.30 |
| Overall Width | E | 10.30 BSC | | |
| Molded Package Width | E1 | 7.50 BSC | | |
| Overall Length | D | 11.55 BSC | | |
| Chamfer (optional) | h | 0.25 | – | 0.75 |
| Foot Length | L | 0.40 | – | 1.27 |
| Footprint | L1 | 1.40 REF | | |
| Foot Angle | φ | 0° | – | 8° |
| Lead Thickness | c | 0.20 | – | 0.33 |
| Lead Width | b | 0.31 | – | 0.51 |
| Mold Draft Angle Top | α | 5° | – | 15° |
| Mold Draft Angle Bottom | β | 5° | – | 15° |

Notes:

- Pin 1 visual index feature may vary, but must be located within the hatched area.
- § Significant Characteristic.
- Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.15 mm per side.
- Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-051B

MCP23009/MCP23S09

20-Lead Plastic Shrink Small Outline (SS) – 5.30 mm Body [SSOP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



| Dimension Limits | Units | MILLIMETERS | | |
|--------------------------|--------|-------------|------|------|
| | | MIN | NOM | MAX |
| Number of Pins | N | 20 | | |
| Pitch | e | 0.65 BSC | | |
| Overall Height | A | – | – | 2.00 |
| Molded Package Thickness | A2 | 1.65 | 1.75 | 1.85 |
| Standoff | A1 | 0.05 | – | – |
| Overall Width | E | 7.40 | 7.80 | 8.20 |
| Molded Package Width | E1 | 5.00 | 5.30 | 5.60 |
| Overall Length | D | 6.90 | 7.20 | 7.50 |
| Foot Length | L | 0.55 | 0.75 | 0.95 |
| Footprint | L1 | 1.25 REF | | |
| Lead Thickness | c | 0.09 | – | 0.25 |
| Foot Angle | ϕ | 0° | 4° | 8° |
| Lead Width | b | 0.22 | – | 0.38 |

Notes:

- Pin 1 visual index feature may vary, but must be located within the hatched area.
- Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.20 mm per side.
- Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-072B

APPENDIX A: REVISION HISTORY

Revision B (May 2009)

The following is the list of modifications:

1. Added the 3x3 QFN package (MG package marking).
2. Updated Revision History.

Revision A (December 2008)

- Original Release of this Document.

MCP23009/MCP23S09

NOTES:

MCP23009/MCP23S09

PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

| <u>PART NO.</u> | <u>X</u> | <u>/XX</u> | |
|-------------------|-------------------|--|--|
| Device | Temperature Range | Package | |
| Device | MCP23009: | 8-Bit I/O Expander w/ I ² C™ Interface | |
| | MCP23009T: | 8-Bit I/O Expander w/ I ² C Interface (Tape and Reel) | |
| | MCP23S09: | 8-Bit I/O Expander w/ SPI Interface | |
| | MCP23S09T: | 8-Bit I/O Expander w/ SPI Interface (Tape and Reel) | |
| Temperature Range | E | = -40°C to +125°C (Extended) * | |
| Package | MG | = Plastic Quad Flat, No Lead Package (3x3x0.9 mm Body), 16-Lead | |
| | P | = Plastic DIP (300 mil Body), 18-Lead | |
| | SO | = Plastic SOIC (300 mil Body), 18-Lead | |
| | SS | = Plastic SSOP (5.3 mm), 20-Lead | |

| Examples: | |
|--------------------|---|
| a) MCP23009-E/P: | Extended Temp., 18LD PDIP package. |
| b) MCP23009-E/SO: | Extended Temp., 18LD SOIC package. |
| c) MCP23009T-E/SO: | Tape and Reel, Extended Temp., 18LD SOIC package. |
| d) MCP23009-E/SS: | Extended Temp., 20LD SSOP package. |
| e) MCP23009T-E/SS: | Tape and Reel, Extended Temp., 20LD SSOP package. |
| f) MCP23009-E/MG: | Extended Temp., 16LD QFN package. |
| | |
| a) MCP23S09-E/P: | Extended Temp., 18LD PDIP package. |
| b) MCP23S09-E/SO: | Extended Temp., 18LD SOIC package. |
| c) MCP23S09T-E/SO: | Tape and Reel, Extended Temp., 18LD SOIC package. |
| d) MCP23S09T-E/MG: | Tape and Reel, Extended Temp., 16LD QFN package. |

MCP23009/MCP23S09

NOTES:

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